

# TD350E

### Advanced IGBT/MOSFET driver

Datasheet - production data



### Features

- 1.5 A source/2.3 A sink (typ.) gate drive
- Active Miller clamp feature
- Two-level turn-off with adjustable level and delay
- Desaturation detection
- Fault status output
- Negative gate drive capability
- Input compatible with pulse transformer or optocoupler
- Separate sink and source outputs for easy gate driving
- UVLO protection
- 2 kV ESD protection (HBM)

### Applications

- 1200 V, 3-phase inverters
- Motor control
- UPS systems

### Description

The TD350E device is an advanced gate driver for IGBTs and power MOSFETs. Control and protection functions are included and allow the design of high reliability systems.

The innovative active Miller clamp function eliminates the need for negative gate drive in most applications and allows the use of a simple bootstrap supply for the high side driver.

The device includes a two-level turn-off feature with adjustable level and delay. This function protects against excessive overvoltage at turn-off in case of overcurrent or short-circuit conditions. The same delay set in the two-level turn-off feature is applied at turn-on to prevent pulse width distortion.

The device also includes IGBT desaturation protection and a FAULT status output, and is compatible with both pulse transformer and optocoupler signals.

Table	1.	Device	summary
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Order code	Temperature range	Package	Packaging		
TD350E	-40, +125 °C	SO-14	Tube		
TD350ETR			Tape and reel		

This is information on a product in full production.

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## 1 Block diagram







## 2 Pin connections

IN [ 1		14 ] DE	ESAT
VREF [ 2		13 ] ∨⊦	1
FAULT [ 3		12 ] OL	JTH
NC [ 4	TD350E	11 ] OL	JTL
COFF [ 5		10 UL	
NC [ 6		9 ] CL	AMP
LVOFF [ 7		8 ] GN	ND
			AM02720v1

#### Figure 2. Pin connections (top view)

Name	Pin number	Туре	Function
IN	1	Analog input	Input
VREF	2	Analog output	+5 V reference voltage
FAULT	3	Digital output	Fault status output
NC	4	Not connected	
COFF	5	Timing capacitor	Turn-off delay
NC	6	Not connected	
LVOFF	7	Analog input	Turn-off level
GND	8	Power supply	Signal ground
CLAMP	9	Analog output	Miller clamp
VL	10	Power supply	Negative supply
OUTL	11	Analog output	Gate drive output (sink)
OUTH	12	Analog output	Gate drive output (source)
VH	13	Power supply	Positive supply
DESAT	14	Analog input	Desaturation protection

#### Table 2. Pin description



## 3 Absolute maximum ratings

Symbol	Parameter	Value	Unit
VHL	Maximum supply voltage (VH - VL)	28	V
VH	Maximum VH voltage vs. GND	28	V
VL	Minimum VL voltage vs. GND	-12	V
V <sub>out</sub>	Voltage on OUTH, OUTL, CLAMP pins	VL - 0.3 to VH + 0.3	V
V <sub>des</sub>	Voltage on DESAT, FAULT, LVOFF pin	-0.3 to VH + 0.3	V
Vother	Voltage on other pins (IN, COFF, VREF)	-0.3 to 7	V
Pd	Power dissipation	500	mW
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
Тj	Maximum junction temperature	150	°C
R <sub>thja</sub>	Thermal resistance junction-ambient	125	°C/W
R <sub>thjc</sub>	Thermal resistance junction-case	22	°C/W
ESD	Electrostatic discharge (HBM)	2	kV

#### Table 4. Operating conditions

Symbol	Parameter	Value	Unit
VH	Positive supply voltage vs. GND	UVLO to 26	V
VL	Negative supply voltage vs. GND	0 to -10	V
VH-VL	Maximum total supply voltage	26	V
T <sub>oper</sub>	Operating free air temperature range	-40 to 125	°C



## 4 Electrical characteristics

 $T_A$  = -20 to 125 °C, VH = 16 V, VL = -10 V (unless otherwise specified).

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Input						
V <sub>ton</sub>	IN turn-on threshold voltage		0.8	1.0		V
V <sub>toff</sub>	IN turn-off threshold voltage			4.0	4.2	V
t <sub>onmin</sub>	Minimum pulse width		100	135	220	ns
I <sub>inp</sub>	IN input current				1	μA
Voltage i	reference <sup>(1)</sup>					
V <sub>ref</sub>	Voltage reference	T = 25 °C $T_{min} < T < T_{max}$	4.85 4.77	5.00	5.15 5.22	V V
I <sub>ref</sub>	Maximum output current		10			mA
Desatura	ation protection					
V <sub>des</sub>	Desaturation threshold		6.5	7.2	7.9	V
I <sub>des</sub>	Source current			250		μA
Fault ou	tput					
t <sub>fault</sub>	Delay for fault detection				500	ns
$V_{FL}$	FAULT low voltage	I <sub>FLsink</sub> = 10 mA			1	V
Clamp				•		
V <sub>tclamp</sub>	CLAMP pin voltage threshold			2.0		V
V <sub>CL</sub>	Clamp low voltage	T = 25 °C; $I_{CLsink}$ = 500 mA T <sub>min</sub> < T < T <sub>max</sub> ; $I_{CLsink}$ = 500 mA			VL + 2.5 VL + 3.0	V V
Off delay	/					
V <sub>tdel</sub>	Voltage threshold		2.35	2.50	2.65	V
R <sub>del</sub>	Discharge resistor	I = 1 mA			500	Ω
Off level	S			•		
I <sub>blvoff</sub>	LVOFF peak input current (sink)	LVOFF = 12 V		120	200	μA
V <sub>iolv</sub>	Offset voltage	LVOFF = 12 V	-0.3	-0.15	0	V
Outputs		•			•	
V <sub>OL1</sub>	Output low voltage	I <sub>osink</sub> = 20 mA			VL + 0.35	V
V <sub>OL2</sub>	Output low voltage	T = 25 °C, $I_{osink}$ = 200 mA T <sub>min</sub> < T < T <sub>max</sub> , $I_{osink}$ = 200 mA			VL +1.0 VL +1.5	V V

#### Table 5. Electrical characteristics



Symbol	Parameter	Test condition	, Min.	Тур.	Max.	Unit
V <sub>OL3</sub>	Output low voltage	T = 25 °C, $I_{osink}$ = 500 mA T <sub>min</sub> < T < T <sub>max</sub> , $I_{osink}$ = 500 mA		-	VL + 2.5 VL + 3.0	V V
V <sub>OH1</sub>	Output high voltage 1	I <sub>osource</sub> = 20 mA	VH - 2.5			V
V <sub>OH2</sub>	Output high voltage 2	I <sub>osource</sub> = 200 mA	VH - 3.0			V
V <sub>OH3</sub>	Output high voltage 3	I <sub>osource</sub> = 500 mA	VH - 4.0			V
t <sub>r</sub>	Rise time	C <sub>L</sub> = 1 nF, 10% to 90% VL = 0 VL = -10 V			130 175	ns ns
t <sub>f</sub>	Fall time <sup>(2)</sup>	C <sub>L</sub> = 1 nF, 90% to 10% VL = 0 VL = -10 V			75 90	ns ns
	Turn-on propagation delay	10% output change; T = 25 °C	400	500	600	ns
t <sub>pd_on</sub>	Tum-on propagation delay	10% output change; T <sub>min</sub> < T < T <sub>max</sub>	350		650	ns
L	Turn off annual firm data.	10% output change; T = 25 °C	350	450	570	ns
t <sub>pd_off</sub> Turn-off propagation de	Tum-on propagation delay	10% output change; T <sub>min</sub> < T < T <sub>max</sub>	300		620	ns
$\Delta T_{W}$	Input to output pulse distortion	10% output change	25	50	120	ns
Undervo	Itage lockout (UVLO)					
UVLOH	UVLO top threshold		10	11	12	V
UVLOL	UVLO bottom threshold		9	10	11	V
V <sub>hyst</sub>	UVLO hysteresis	UVLOH - UVLOL	0.5	1		V
Supply o	current				4	
l <sub>in</sub>	Quiescent current	Output = 0 V, no load			5	mA

Table 5. Electrical characteristics (continued)

1. Recommended capacitor range on VREF pin is 10 nF to 100 nF.

2. 2-step turn-off disabled.



### 5 Functional description

#### 5.1 Input

The input is compatible with optocouplers or pulse transformers. The input is triggered by the signal edge and allows the use of a small-sized, low cost pulse transformer. Input is active low (output is high when input is low) to ease the use of the optocoupler. When driven by a pulse transformer, the input pulse (positive and negative) width must be larger than the minimum pulse width  $t_{onmin}$ .

### 5.2 Voltage reference

A voltage reference is used to create accurate timing for the two-level turn-off with external resistor and capacitor.

### 5.3 Desaturation protection

Desaturation protection ensures the protection of the IGBT in the event of overcurrent. When the DESAT voltage goes higher than 7 V, the output is driven low (with 2-level turn-off, if applicable). The FAULT output is activated. The FAULT state is exited at the next falling edge of IN input.

A programmable blanking time is used to allow enough time for IGBT saturation. Blanking time is provided by an internal current source and external capacitor.

DESAT input can also be used with an external comparator for overcurrent or overtemperature detection.

### 5.4 Active Miller clamp

A Miller clamp allows the control of the Miller current during a high dV/dt situation and can eliminate the need for a negative supply voltage.

During turn-off, the gate voltage is monitored and the clamp output is activated when gate voltage goes below 2 V (relative to GND). The clamp voltage is VL+3 V max. for a Miller current up to 500 mA. The clamp is disabled when the IN input is triggered again.

### 5.5 Two-level turn-off

The two-level turn-off is used to increase the reliability of the application.

During turn-off, gate voltage can be reduced to a programmable level in order to reduce the IGBT current (in the event of overcurrent). This action prevents both dangerous overvoltage across the IGBT and RBSOA problems, especially at short-circuit turn-off.

The two-level turn-off ( $T_a$ ) delay is programmable through an external resistor and capacitor for accurate timing (refer to *Equation 1*).

Turn-off delay  $(T_a)$  is also used to delay the input signal to prevent distortion of input pulse width.





#### Equation 1

 $T_a \left[ \mu s \right] \cong 0.7 \bullet R_{off} \left[ k\Omega \right] \bullet C_{off} \left[ nF \right]$ 

### 5.6 Minimum ON time

In order to ensure the proper operation of the 2-level turn-off function, the input ON time  $(T_{win})$  must be greater than the  $T_{winmin}$  value:

#### Equation 2

 $T_{winmin} = T_a + 2 \cdot R_{del} \cdot C_{off}$ 

R<sub>del</sub> is the internal discharge resistor and C<sub>off</sub> is the external timing capacitor.

Input signals smaller than  $T_a$  are ignored. Input signals larger than  $T_{winmin}$  are transmitted to the output stage after the  $T_a$  delay with minimum width distortion ( $\Delta T_w = T_{wout} - T_{win}$ ).

For an input signal width  $T_{win}$  between  $T_a$  and  $T_{winmin}$ , the output width  $T_{wout}$  is reduced below  $T_{win}$  (pulse distortion) and the IGBT could be partially turned on. These input signals should be avoided during normal operation.

#### 5.7 Output

The output stage is able to sink 2.3 A and source 1.5 A (typ.) at 25  $^{\circ}$ C (1.2 A/0.75 A minimum over the full temperature range). Separate sink and source outputs allow independent gate charge and discharge control without an extra external diode.

### 5.8 Fault status output

Fault output is used to signal a fault event (desaturation, UVLO) to a controller. The fault pin is designed to drive an optocoupler.

### 5.9 Undervoltage protection

Undervoltage detection protects the application in the event of a low VH supply voltage (during startup or a fault situation). During undervoltage, the OUTH pin is open and the OUTL pin is driven low (active pull-down for VH > 2 V, passive pull-down for VH < 2 V). Fault output signals the undervoltage state and is reset only when undervoltage state disappears.









Figure 4. Detailed internal schematic



## 6 Timing diagrams



Figure 5. Turn-on and turn-off

Figure 6. Minimum ON time



#### Figure 7. Desaturation fault





I<sub>osink</sub> = 500 mA

I<sub>osink</sub> = 200 mA

I<sub>osink</sub> = 20 mA

100

125

AM03263

75

#### TD350E

### 7 Typical performance curves







Figure 12. High level output voltage vs. temperature



Temp (°C)

25

50

Figure 9. Low level output voltage vs. temp.

3.0

2.0

1.0

0.0

-50

-25

0

VOL-VL (V)



Figure 13. Desaturation source current vs. temperature



## 8 Application diagrams



#### Figure 14. Single supply IGBT drive with active Miller clamp and 2-level turn-off





#### Figure 16. Use of DESAT input for direct overcurrent detection





## 9 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Figure 17. Package SO-14 package outline



Table 6. SO-14 package mechanical data					
Symbol	Dimensions (mm)				
Symbol	Min.	Тур.	Max.		
А	1.35		1.75		
A1	0.10		0.25		
A2	1.10		1.65		
В	0.33		0.51		
С	0.19		0.25		
D	8.55		8.75		
E	3.80		4.00		
е		1.27			
Н	5.80		6.20		
h	0.25		0.50		
L	0.40		1.27		
k	0		8		
ddd			0.10		

Table 6 SO-14 .... anical dat .



## 10 Revision history

Date	Revision	Changes
08-Mar-2011	1	First release.
21-Sep-2011	2	<ul> <li>Updated Table 1</li> <li>Minor text changes throughout the document</li> </ul>
13-Jun-2013	3	Updated <i>Figure 1</i> , <i>Figure 4</i> to <i>Figure 7</i> , <i>Figure 9</i> to <i>Figure 16</i> (minor corrections). Updated <i>Figure 3</i> (replaced "VCCmin" by "2 V"). Updated <i>Table 5</i> (moved "I <sub>osink</sub> " for "V <sub>OL1/2/3</sub> " symbols to "Test condition"). Updated <i>Section 5.5</i> (replaced "Turn-off" by "The two-level turn-off", added <i>Equation 1</i> ). Updated <i>Section 5.6</i> (added heading for <i>Equation 2</i> ). Updated <i>Table 6</i> (updated data, reversed order of <i>Figure 17</i> and <i>Table 6</i> ). Minor corrections throughout document.



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